SHARP	No.	LD-25258A
	DATE REV.	14-Feb-13
TECHNICAL LITERATU	JRE	
FOR		
TFT - LCD modu	le)
MODEL NO. LQ043T1D	<u>G29</u>	
These parts have corresponded with the	RoHS	directive.
The technical literature is subject to change of So, please contact SHARP or its representation designing your product based on this literature.	ve before	ice.
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RECORDS OF REVISION

LQ043T1DG29

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SPEC No.	DATE	SED No	PAGE	SUMMARY	NOTE	
LD-25258A	2013/2/14			_		

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1. Applicable Scope

This technical literature is applicable to TFT-LCD Module "LQ043T1DG29".

2. General Description

This module is a color active matrix LCD module incorporating amorphous silicon TFT (Thin Film Transistor). It is composed of a color TFT-LCD panel, driver IC, Input FPC, a back light unit and touch panel. Graphics and texts can be displayed on a 480 x 272 x RGB dots panel with about 262k colors by supplying 18bit data signals (6bit x RGB), four timing signals, 3wires 24bit serial interface signals, logic (Typ. +3.3V), analog (Typ. +3.3V) supply voltages for TFT-LCD panel driving and supply voltage for back light.

3. Mechanical (Physical) Technical literatures

Item	Specifications	Unit
Screen size	10.9 (4.3" type) diagonal	cm
Active area	95.04 (H) × 53.856 (V)	mm
Divelformet	480 (H) x 272 (V)	pixel
Pixel format	1Pixel =R+G+B dots	-
Pixel pitch	0.198 (H) x 0.198 (V)	mm
Pixel configuration	R,G,B horizontal stripes	-
Display mode	Normally white	-
Unit outline dimensions	105.5 (W) x 67.2 (H) x 3.1 (D)	mm
Mass	About 36	g
Surface hardness	2H	-
Surface treatment	Anti glare	-

%The above-mentioned table indicates module sizes without some projections and FPC.

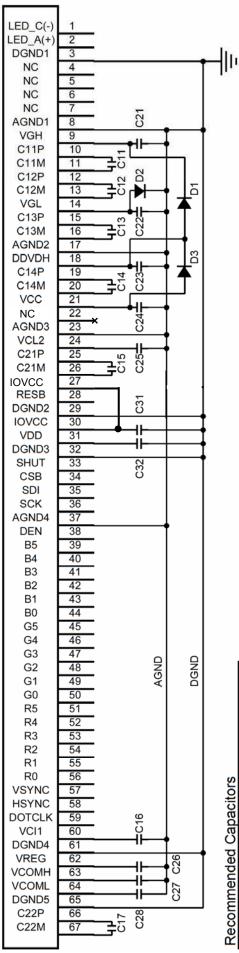
For detailed measurements and tolerances, please refer to 18. Outline Dimensions.

4. Input Terminal Names and Functions

Recommendation CN : [HIROSE] FH26G-67S-0.3SHBW(05) or [KYOCERA ELCO] 00 6281 067 2X2 829 +

Pin No	Symbol	I/O	Description	Remarks
1	LED C (-)	-	Power supply for LED (Cathode)	
2	LED_A(+)	-	Power supply for LED (Anode)	
3	DGND1	-	Digital Ground	
4	NC	-	No connection	
5	NC	-	No connection	
6	NC	-	No connection	
7	NC	-	No connection	
8	AGND1	-	Analog Ground	
9	VGH	-	Connect a Stabilizing capacitor to GND	Note 4-1
10	C11P	-	Connect a Booster capacitor to C11M	Note 4-1
11	C11M	-	Connect a Booster capacitor to C11P	Note 4-1
12	C12P	-	Connect a Booster capacitor to C12M	Note 4-1
13	C12M	-	Connect a Booster capacitor to C12P	Note 4-1
14	VGL	-	Connect a Stabilizing capacitor to GND	Note 4-1
15	C13P	-	Connect a Booster capacitor to C13M	Note 4-1
16	C13M	-	Connect a Booster capacitor to C13P	Note 4-1
17	AGND2	-	Analog Ground	
18	DDVDH	-	Connect a Stabilizing capacitor to GND	Note 4-1
19	C14P	-	Connect a Booster capacitor to C14M	Note 4-1
20	C14M	-	Connect a Booster capacitor to C14P	Note 4-1
21	VCC	-	Booster input voltage pin	
22	NC	-	No connection	
23	AGND3	-	Analog Ground	
24	VCL2	-	Connect a Stabilizing capacitor to GND	Note 4-1
25	C21P	-	Connect a Booster capacitor to C21M	Note 4-1
26	C21M	-	Connect a Booster capacitor to C21P	Note 4-1
27	IOVCC	-	Voltage input pin for logic I/O	Note 4-1
28	RESB	Ι	System reset	
29	DGND2	-	Digital Ground	
30	IOVCC	-	Voltage input pin for logic I/O	
31	VDD	-	Connect a Stabilizing capacitor to GND	Note 4-1
32	DGND3	-	Digital Ground	
33	SHUT	Ι	Sleep mode control	
34	CSB	Ι	Chip select pin of serial interface	
35	SDI	Ι	Data input pin in serial mode	
36	SCK	Ι	Clock input pin in serial mode	
37	AGND4	-	Analog Ground	Note 4-1
38	DEN	Ι	Display enable signal	
39	B5	Ι	BLUE data signal(MSB)	
40	B4	Ι	BLUE data signal	
41	B3	I	BLUE data signal	

Pin No.	Symbol	I/O	Description	Remarks
42	B2	I	BLUE data signal	
43	B1	Ι	BLUE data signal	
44	B0	I	BLUE data signal(LSB)	
45	G5	I	GREEN data signal(MSB)	
46	G4	Ι	GREEN data signal	
47	G3	Ι	GREEN data signal	
48	G2	Ι	GREEN data signal	
49	G1	Ι	GREEN data signal	
50	G0	I	GREEN data signal(LSB)	
51	R5	Ι	RED data signal(MSB)	
52	R4	Ι	RED data signal	
53	R3	I	RED data signal	
54	R2	I	RED data signal	
55	R1	Ι	RED data signal	
56	R0		RED data signal(LSB)	
57	VSYNC		Frame synchronization signal	
58	HSYNC		Line synchronization signal	
59	DOTCLK	I	Dot-clock signal	
60	VCI1	-	Connect a Stabilizing capacitor to GND	Note 4-1
61	DGND4	-	Digital Ground	
62	VREG	-	Connect a Stabilizing capacitor to GND	Note 4-1
63	VCOMH	-	Connect a Stabilizing capacitor to GND	Note 4-1
64	VCOML	-	Connect a Stabilizing capacitor to GND	Note 4-1
65	DGND5	-	Digital Ground	
66	C22P	-	Connect a Booster capacitor to C22M	Note 4-1
67	C22M	-	Connect a Booster capacitor to C22P	Note 4-1



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Temperature Characteristic	B(JIS) or X5R(EIA)	וא@25°C, VR≧25V	וא@25°C, VR≧25V	<0.38V/5mA@25°C, VR≧25V																
Rated Voltage	6.3 V	6.3 V	6.3 V	6.3 V	10 V	6.3 V	10 V	25 V	25 V	10 V	6.3 V	6.3 V	10 V	10 V	6.3 V	6.3 V	6.3 V	VF < 0.38V/5mA@25°C,	Schottky diodeVF<0.38V/5mA@25°C,	V 1
Capacitance	1 µF	2.2 µF	1 µF	2.2 µF	2.2 µF	4.7 µF	2.2 µF	4.7 µF	4.7 µF	4.7 µF	4.7 µF	2.2 µF	2.2 µF	Schottky diodeVF	Schottky diode	Schottky diod∉VF				
Ref No.	C11	C12	C13	C14	C15	C16	C17	C21	C22	C23	C24	C25	C26	C27	C28	C31	C32	D1	D2	D3

[Note]

Also aware the PCB design to avoid other components to be affected by noise on those dcdc pins. C11P/M, C12P/M, C13P/M, C14P/M, C21P/M, C22P/M are high voltage switching lines on FPC. Surround/shield by AGND to avoid noise coupling to other pins.

[Note 4-1] Recommended Capacitors and Diodes

5. Absolute Maximum Ratings

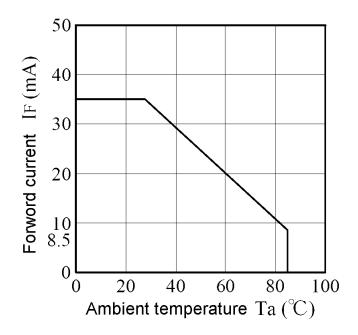
Item	Symbol	Conditions	Rated value	Unit	Remarks
Input voltage	VI	Ta = 25°C	-0.3 ~ IOVCC+0.3	V	Note 5-1
Logic I/O power supply voltage	IOVCC	Ta = 25°C	-0.3 ~ +4.0	V	
Analog power supply voltage	VCC	Ta = 25°C	AGND-0.3 ~ +4.6	V	
Temperature for storage	Tstg	-	-30~ +85	°C	Note 5-2
Temperature for operation	Topr	-	-10 ~ +70	°C	Note 5-2, 5-3
LED input electric current	I _{LED}	Ta = 25°C	35	mA	Note 5-4
LED electricity consumption	P_{LED}	Ta = 25°C	123	mW	Note 5-4

[Note 5-1] RESB, SHUT, CSB, SDI, SCK, DEN, B5~B0, G5~G0, R5~R0, VSYNC, HSYNC, DOTCLK [Note 5-2] Humidity: 95%RH Max. (Ta≦40°C)

Maximum bulb temperature under 39°C (Ta>40°C) See to it that no dew will be condensed. [Note 5-3] The high temperature is the panel surface temperature regulations.

[Note 5-4] Power consumption of one LED (Ta = 25° C).

Ambient temperature and the maximum input are fulfilling the following operating conditions.



6. Electrical Characteristics

6-1. TFT LCD Panel Driving	

							Ta = 25°C
lt	em	Symbol	Min.	Тур.	Max.	Unit	Remarks
Logic I/O	DC voltage	IOVCC	+3.0	+3.3	+3.6	V	
power supply	DC current	I _{IOVCC}	-	0.1	0.2	mA	Note 6-1
Analog	DC voltage	VCC	+3.2	+3.3	+3.4	V	Note 6-1 Note 6-6
power supply	DC current	I _{VCC}	-	16	24	mA	Note 6-3
Permis	sive input	V _{RFIOVCC}	-	-	100	mVp-p	Note 6-4
Ripple	voltage	V _{RFVCC}	-	-	100	mVp-p	Note 6-4
Logic	High	V _{IH}	0.8xIOVCC	-	IOVCC	V	Note 6-5
Input Voltage	Low	V _{IL}	0	-	0.2xIOVCC	V	Note 6-5
Logic input Current		I _{IH} / I _{IL}	-1	-	1	μA	Note 6-5

[Note 6-1] IOVCC = +3.3V, VCC = +3.3V, f_{VSYNC} = 60Hz

Current situation for I_{IOVCC}: Black & White checker flag pattern

[Note 6-2] Refer to Recommended Capacitors and Register setting.

[Note 6-3] IOVCC = +3.3V, VCC = +3.3V, f_{VSYNC} = 60Hz

Current situation for I_{VCC} : All black pattern

[Note 6-4] IOVCC = +3.3V, VCC = +3.3V

[Note 6-5] RESB, SHUT, CSB, SDI, SCK, DEN, B5~B0, G5~G0, R5~R0, VSYNC, HSYNC, DOTCLK

[Note 6-6] When it is out of the above recommended operating voltage, for example, in case of

 $+3.0V \leq VCC < +3.3V$, $+3.4V < VCC \leq +3.6V$, the module does not break.

But the deterioration of display quality, flicker etc., may be occurred.

6-2. Register Setting

IOVCC and VCC ON (%hold RESB = "L", hold SHUT = "H")

Wait min. 1ms

Hard Reset ($\overset{v}{\text{RESB}}$ "L" \rightarrow "H")

it may 1

Wait max.100us

Display Data Start (DOTCLK, HSYNC, VSYNC)

Register Setting (%)

D <i>U</i>		Data	
Reg.#	Register	(Gamma2.2)	Remark
R00 h	Panel Driving Control	0013 h	Note 6-7
R01 h	Power Control 1	9A09 h	
R02 h	Power Control 2	9A11 h	
R03 h	Power Control 3	1100 h	
R04 h	Power Control 4	1100 h	
R05 h	Power Control 5	0232 h	
R06 h	Horizontal Back Porch Control	000E h	Note 6-8
R07 h	Vertical Back Porch Control	0004 h	Note 6-9
R09 h	Interface Control	0001 h	
R0A h	Power Control 6	1A61 h	
R0B h	Power Control 7	FF9B h	
R0C h	Power Control 8	00B0 h	
R0D h	Power Control 9	CA53 h	
R0E h	Power Control 10	CA53 h	
R10 h	Gamma Set 1	0616 h	
R11 h	Gamma Set 2	7916 h	
R12 h	Gamma Set 3	0805 h	
R13 h	Gamma Set 4	0217 h	
R14 h	Gamma Set 5	3121 h	
R15 h	Gamma Set 6	1707 h	
R16 h	Gamma Set 7	750F h	
R17 h	Gamma Set 8	1B0D h	
R18 h	Gamma Set 9	0106 h	
R19 h	Gamma Set 10	1112 h	

Wait min. 5ms

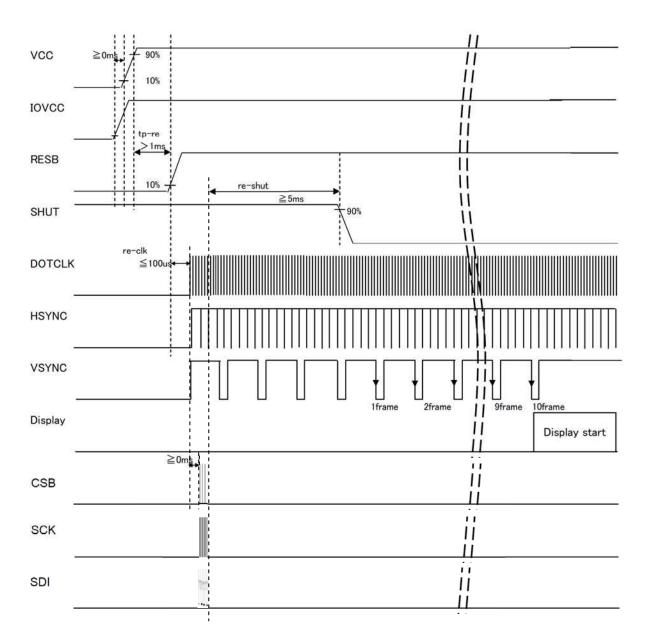
Sleep mode \rightarrow Normal mode conversion (SHUT "H" \rightarrow "L")

Wait min.10 frame ↓ Back light ON

Display ON

XIf a setting other than the Register setting is captured temporarily due to disturbances such as electrostatic discharge, the normal display is restored by transmitting the recommended setting again.

(At this time, it is not necessary to turn on the power again or perform initializing with RESB.)



Characteristics	symbol	Min	Тур	Max	Units
VCC on to rising edge of RESB	tp-re	1	-	-	ms
Register set to Falling edge of SHUT	re-shut	5	-	-	ms
RESB on to rising edge of DOTCLK	re-clk	-	-	100	usec
Falling edge of SHUT to display start		-	-	10	frame
1 line: 512 clk					
1 frame: 278 line	tshut-on	-	167	-	msec
PIXCLK = 8.5MHz					

*Display starts at 10th falling edge of VSYNC after the falling edge of SHUT.

[Note 6-7]

Panel Driving Control (R00h)

F	R/W	DC	IB15	IB14	IB13	IB12	IB11	IB10	IB9	IB8	IB7	IB6	IB5	IB4	IB3	IB2	IB1	IB0
	W	1	0	RL	0	0	0	0	ТВ	0	0	0	0	1	0	0	1	1
	PC)R	0	0	0	0	0	0	0	0	0	0	0	1	0	0	1	1

TB: Selects the output shift direction of the gate driver.

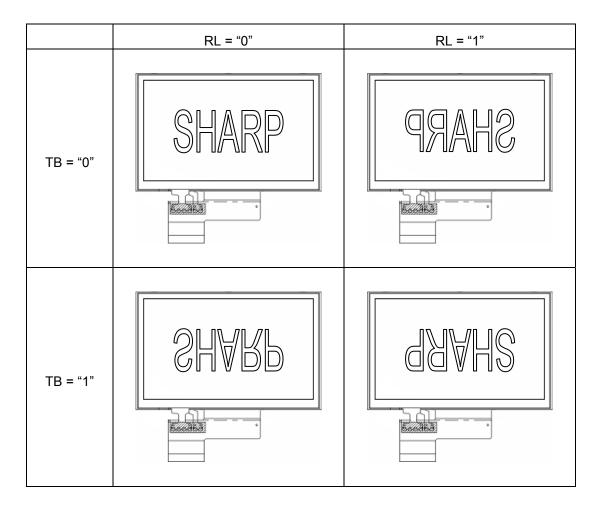
When TB = "0", Top shifts to Bottom.

When TB = "1", Bottom shifts to Top.

RL: Selects the output shift direction of the source driver.

When RL ="0", Left shifts to Right.

When RL ="1", Right shifts to Left.



[Note 6-8]

Horizontal Back Porch Control (R06h)

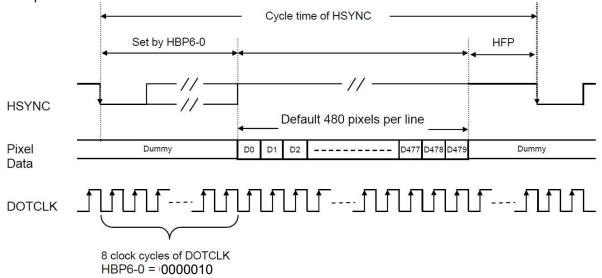
R/W	DC	IB15	IB14	IB13	IB12	IB11	IB10	IB9	IB8	IB7	IB6	IB5	IB4	IB3	IB2	IB1	IB0
W	1	0	0	0	0	0	0	0	0	0	HBP6	HBP5	HBP4	HBP3	HBP2	HBP1	HBP0
PC	DR	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	0

Number of DOTCLK for HSYNC active low period must be smaller than that of HBP.

HBP6-0: Set the delay period from falling edge of HSYNC signal to first valid data.

HBP6	HBP5	HBP4	HBP3	HBP2	HBP1	HBP0	No. of clock cycle of DOTCLK
0	0	0	0	1	0	0	2
0	0	0	0	1	0	1	3
0	0	0	0	1	1	0	4
0	0	0	0	1	1	1	5
0	0	0	0	0	0	0	6
0	0	0	0	0	0	1	7
0	0	0	0	0	1	0	8
0	0	0	0	0	1	1	9
0	0	0	1	1	0	0	10
				:			:
				:			Step = 1
					-		:
1	1	1	0	0	1	1	121
1	1	1	1	1	0	0	122
1	1	1	1	1	0	1	123
1	1	1	1	1	1	0	124
1	1	1	1	1	1	1	125
1	1	1	1	0	0	0	126
1	1	1	1	0	0	1	127
1	1	1	1	0	1	0	128
1	1	1	1	0	1	1	129

Example



[Note 6-9]

Vertical Back Porch Control (R07h)

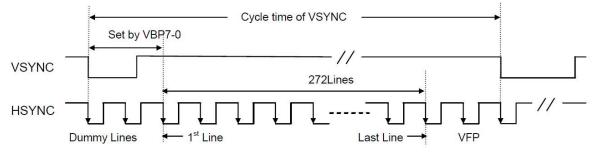
_	R/W	DC	IB15	IB14	IB13	IB12	IB11	IB10	IB9	IB8	IB7	IB6	IB5	IB4	IB3	IB2	IB1	IB0
	W	1	0	0	0	0	0	0	0	0	VBP7	VBP6	VBP5	VBP4	VBP3	VBP2	VBP1	VBP0
	PC	DR	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1

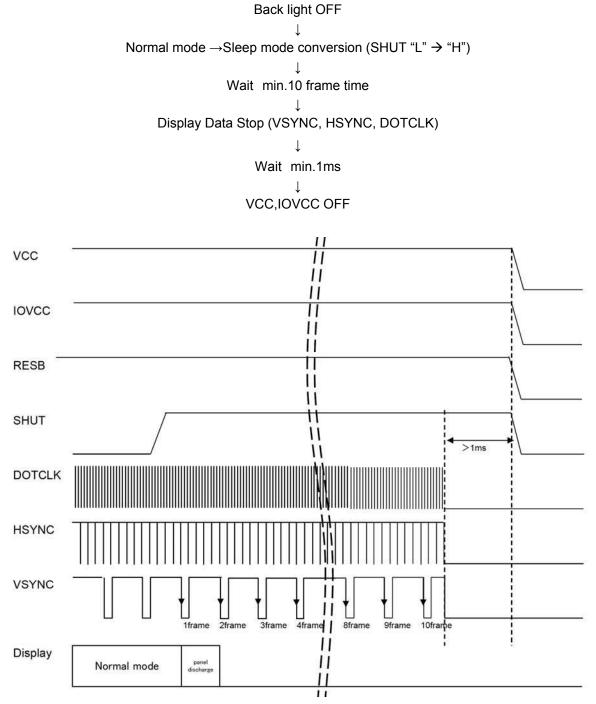
VBP7-0: Set the delay period from falling edge of VSYNC to first valid line.

The line data within this delay period will be treated as dummy line.

VBP7	VBP6	VBP5	VBP4	VBP3	VBP2	VBP1	VBP0	No. of clock cycle of HSYNC
0	0	0	0	0	0	0	0	Setting inhibited
0	0	0	0	0	0	0	1	1
0	0	0	0	0	0	1	0	2
0	0	0	0	0	0	1	1	3
0	0	0	0	0	1	0	0	4
			:					
			:					Step = 1
			:					
1	1	1	0	0	0	0	0	224
1	1	1	0	0	0	0	1	225
1	1	1	1	*	*	*	*	Reserved







Characteristics	symbol	Min	Тур	Max	Units
Rising edge of SHUT to input-signal off	Tshut-dotclk Off	10	-	-	frame
1 line: 512 clk					
1 frame: 278 line		167	-	-	msec
PIXCLK = 8.5MHz					
Input-signal-off to IOVCC off	toff-vdd	1	-	-	ms

Note1) DOTCLK/HSYNC/VSYNC must be maintained at least 10 frames after the rising edge of SHUT.

Note2) Display become off at the 2nd falling edge of VSYNC after the rising edge of SHUT.

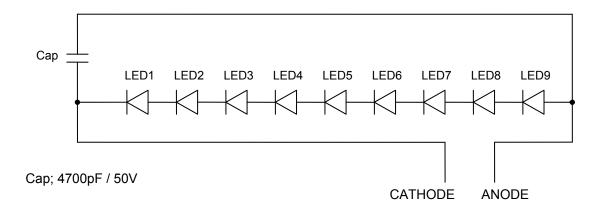
6-4. Back light driving

The back light system has 9 pieces LED

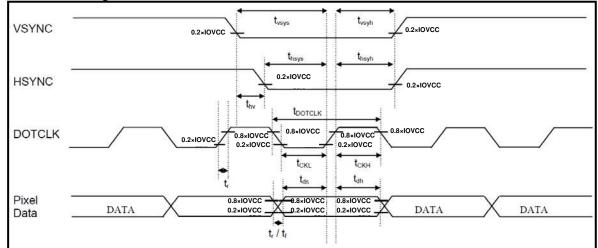
[LED] NSSW006T (Nichia)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Remark
Rated Voltage	V _{BL}	-	28.8	31.5	V	
Rated Current	١L	-	20	-	mA	Ta=25°C
Power consumption	WL	-	576	-	mW	

[LED-FPC circuit]

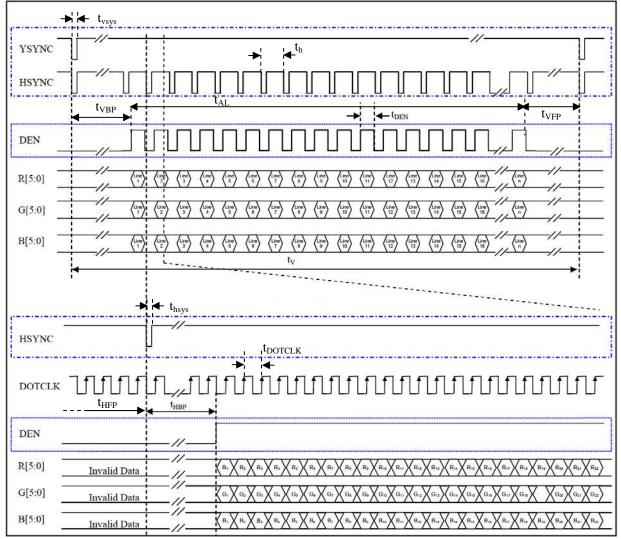


- 7. Timing characteristics of input signals
 - 7-1. Pixel Clock Timing



IOVCC=2.7V~3.6V

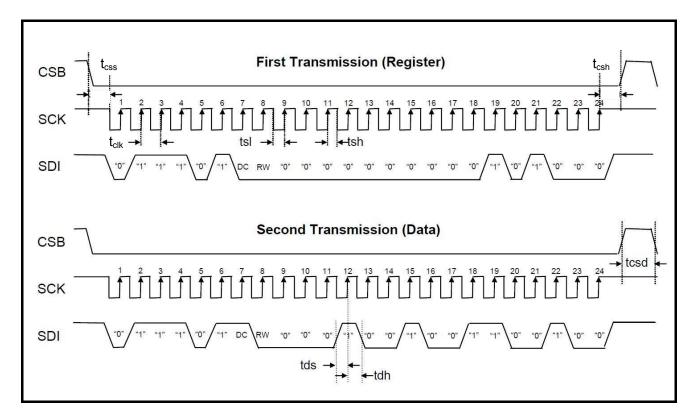
Characteristics	Symbol	Min	Тур	Max	Units
DOTCLK Frequency	f _{DOTCLK}	-	8.54	12	MHz
DOTCLK Period	t _{DOTCLK}	83	-	-	nsec
DOTCLK Low Period	t _{CKL}	41	-	-	nsec
DOTCLK High Period	t _{CKH}	41	-	-	nsec
Vertical Sync Setup Time	t _{vsys}	20	-	-	nsec
Vertical Sync Hold Time	t _{vsyh}	20	-	-	nsec
Horizontal Sync Setup Time	t _{hsys}	20	-	-	nsec
Horizontal Sync Hold Time	t _{hsyh}	20	-	-	nsec
Phase difference of Sync signal falling edge	t _{hv}	0	-	t _н -2	t _{DOTCLK}
Data Setup Time	t _{ds}	20	-	-	nsec
Data Hold Time	t _{dh}	20	-	-	nsec
Rise / Fall Time	t _r / t _f	-	-	10	nsec



7-2. 18-bit RGB Interface Timing Diagram & Transaction Example

	Neresteriation	Symbol	[Units	
(Characteristics		Min	Тур	Max	
Seria	I Clock Frequency	1/t _{DOTCLK}	_	8.54	12.0	MHz
	One Line Period	t _H	505	512	_	t _{DOTCLK}
	Active Data Period	t _{data,} t _{DEN}	480	480	480	t _{DOTCLK}
Horizontal	Horizontal Back Porch	t _{HBP}	2	16	—	t _{DOTCLK}
	Horizontal Front Porch	t _{HFP}	2	16	_	t _{DOTCLK}
	Horizontal sync Period	t _{hsys}	2	_	t _H -2	t _{DOTCLK}
	One Field Period	t _v	275	278	_	t _H
	Active Line Period	t _{AL}	272	272	272	t _H
	Vertical Back Porch	t _{vBP}	2	4	_	t _H
Vertical	Vertical Front Porch	t _{VFP}	1	2	_	t _H
	Vertical sync Period	t _{vsys}	1	2	T _v -2	t _H
	Frequency ※	1/tv	50	60	-	t _H

%If frequency is low, the display grade, flicker and others may become deterioration. Keep frequency over 50Hz(1/Tv). Although this module is operated in DEN mode to decide a horizontal first position, the inputs of not only DEN but Hsync and Vsync are also required.

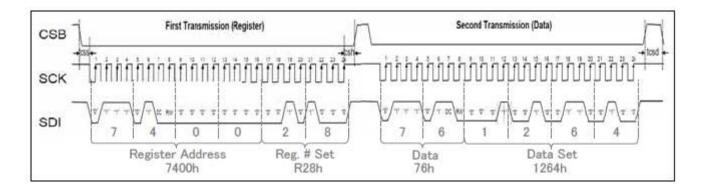


7-3. SPI Interface Timing Diagram & Transaction Example (3-wires 24 bit)

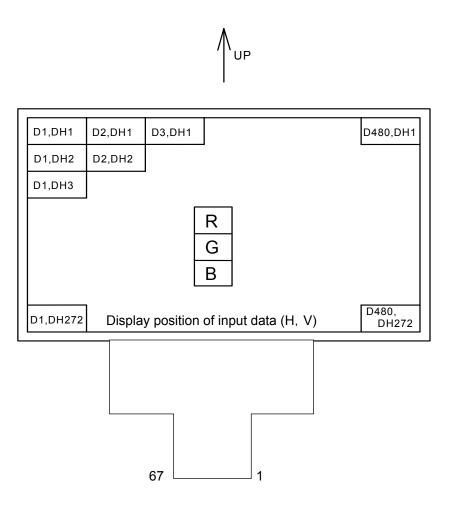
IOVCC=2.7V~3.6V

JVCC=2.7V**3.0V		1	r	1	
Characteristics	symbol	Min	Тур	Max	Units
Serial Clock Frequency	fclk	-	-	20	MHz
Serial Clock Cycle Time	tclk	50	-	-	nsec
Clock Low Width	tsl	25	-	-	nsec
Clock High Width	tsh	25	-	-	nsec
Chip Select Setup Time	tcss	10	-	-	nsec
Chip Select Hold Time	tcsh	10	-	-	nsec
Chip Select High Delay Time	tcsd	25	-	-	nsec
Data Setup Time	tds	10	-	-	nsec
Data Hold Time	tdh	10	-	-	nsec

Register write example example) write [1264h] to Register # [R28h]



7-4. Input Data Signals and Display Position on the screen



8. Input Signals, Basic Colors and Gray Scale of Each Color

	Colors &										e sign	al								
	Gray	Gray	R0	R1	R2	R3	R4	R5	G0	G1	G2	G3	G4	G5	В0	B1	B2	В3	B4	B5
	Scale	Scale	LSB					MSB	LSB	1	1	1		MSB	LSB	1	1	1	1	MSB
	Black	_	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Blue	-	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1
ш	Green	-	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
Basic Color	Cyan	-	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1
Colo	Red	—	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
or	Magenta	-	1	1	1	1	1	1	0	0	0	0	0	0	1	1	1	1	1	1
	Yellow	-	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0
	White	-	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Black	GS0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
0	仓	GS1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Gray Scale of Red	Darker	GS2	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Scal	仓	\checkmark				ŀ					`	r						Ł		
e of	Û	\checkmark								1	、 	1		1		1	, 	Ł	1	
Red	Brighter	GS61	1	0	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Û	GS62	0	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Red	GS63	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Black	GS0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
G	仓	GS1	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0
Gray Sca	Darker	GS2	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0
icale	仓	\checkmark				ŀ					`	r						Ł		
of O	Û	\checkmark								r	``````````````````````````````````````	1		1		1	, I	Ł	r	
le of Green	Brighter	GS61	0	0	0	0	0	0	1	0	1	1	1	1	0	0	0	0	0	0
	Û	GS62	0	0	0	0	0	0	0	1	1	1	1	1	0	0	0	0	0	0
	Green	GS63	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
	Black	GS0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
G	仓	GS1	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0
Gray Scale of Blue	Darker	GS2	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0
Scale	仓	\checkmark				ŀ					`	r						Ł		
e of E	Û	\checkmark												1		1	、 I	₽	1	
3lue	Brighter	GS61	0	0	0	0	0	0	0	0	0	0	0	0	1	0	1	1	1	1
	Û	GS62	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1
	Blue	GS63	0	0	0	0	0	0	0	0	0	0	0	0 el vol	1	1	1	1	1	1

Each basic color can be displayed in 64 gray scales from 6 bit data signals.

According to the combination of 18 bit data signals, the 262k color display can be achieved on the screen.

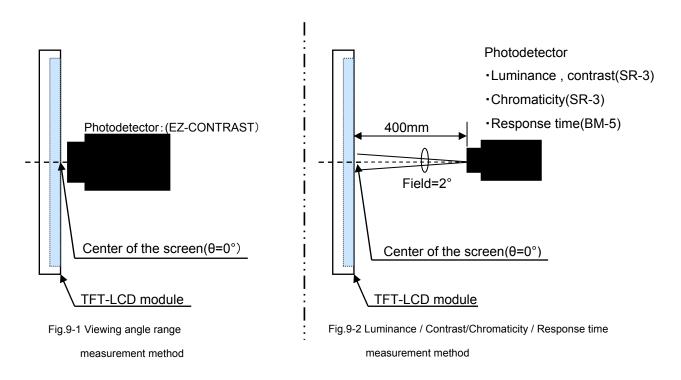
9. Optical Characteristics

Module characteristics

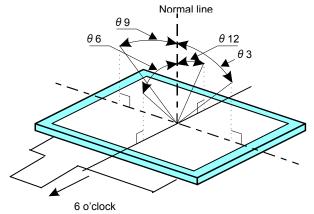
Parameter		Symbol	Condition	Min.	Тур.	Max.	Unit	Remark
Viewing angle range (With Wide View)	Horizontal	θ3	CR≧10	-	80	-	deg.	
		θ9		-	80	-	deg.	[Note 9-1]
	Vertical	θ12		-	55	-	deg.	[Note 9-4]
		θ6		-	80	-	deg.	
Contrast ratio		CR	Optimum viewing angle	250	500	-	-	[Note 9-2] [Note 9-4]
Response	Rise	Tr	0.00	-	22	40	ms	[Note 9-3]
Time	Decay	Td	θ=0°	-	8	20	ms	[Note 9-4]
Chromaticity of		х		0.26	0.31	0.36	-	
White		у		0.29	0.34	0.39	-	[Note 9-4]
Luminance of white		XL		300	360	-	cd/m²	I∟ED=20mA [Note 9-4]
The life of LED (Reference) ILED			ILED=20mA	(10,000)			hour	[Note 9-5]

* The optical characteristics measurements are operated under a stable luminescence

(ILED = 20mA) and a dark condition. (Refer to Fig.9-1 and Fig.9-2)



[Note 9-1] Definitions of viewing angle range



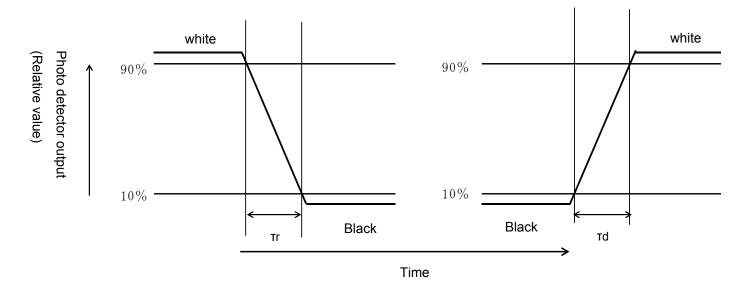
[Note 9-2] Definition of contrast ratio

The contrast ratio is defined as the following

 $Contrast ratio (CR) = \frac{Luminance (brightness) with all pixels white}{Luminance (brightness) with all pixels black}$

[Note 9-3] Definition of response time

The response time is defined as the following figure and shall be measured by switching the input signal for "black" and "white"



[Note 9-4] This shall be measured at center of the screen.

[Note 9-5] The life of LED (Reference)

Luminosity will become 50% on more for an initial value in about 10,000H which condition is Ta=25°C and ILED=20mA.

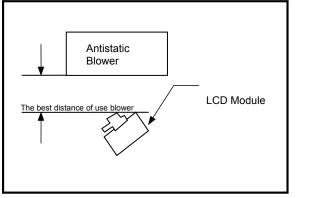
- 10. Handling of modules
- 10-1. Inserting the FPC into its connector and pulling it out.
 - 1) Be sure to turn off the power supply and the signals when inserting or disconnecting the cable.
 - 2) Please insert for too much stress not to join FPC in the case of insertion of FPC.
- 10-2. Handling of FPC
 - 1) The bending radius of the FPC on flexible part should be more than R0.6mm, and it should be bent evenly.
 - 2) Do not dangle the LCD module by holding the FPC, or do not give any stress to it.
 - 3) Do not add stress to the terminal area of FPC and LCD panel.
 - 4) Do not bend FPC to the display direction when handling and mounting.
- 10-3. Mounting of the module
 - 1) The module should be held on to the plain surface. Do not give any warping or twisting stress to the module. Refer to 18.Outline Dimensions about the handling area in surface and gasket area in back. When LCD surface is pushed by the power over 300gf/cm², with use of handling area, the pooling may occur at a different place from the pushed place. Because there is a grade difference in the pooling, check and judge after mounting.
 - 2) Please consider that GND can ground a modular metal portion etc. so that static electricity is not charged to the module.
- 10-4. Cautions in assembly / Handling pre cautions.

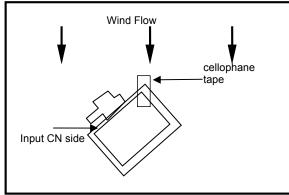
The protect film is attached on the module surface. Remove the film carefully to static electricity as much as possible just before use.

- 1) Notes about removing the protect film on the module surface
- A) Work environments

Since removing laminator may causes electrostatic charge that tends to attract dust, the following work environment would be desired.

- a) Implement more than $1M\Omega$ conductive treatment (by placing a conductive mat or applying conductive paint on the floor or tiles.)
- b) No dusts come in to the working room. Place an adhesive, anti-dust mat at the entrance of the room.
- c) Humidity of 50 to 70% and temperature of 15 to 27°C are desirable.
- d) All workers wear conductive shoes, conductive clothes, conductive fingerstalls and grounding belts without fail.
- B) Instruction for working





- a) Wind direction of an antistatic blower should slightly downward to properly blow the module.
 The distance between the blower and the module should be the best distance of use blower.
 Also, pay attention to the direction of the module. [See the above]
- c) To prevent polarizer from scratching, adhesive tape (cellophane tape) should be stuck at the part of laminator sheet, which is closed to blower. [See the above]
- b) Pull slowly adhesive tape to peel the laminator off, with spending more than 5 second.
- c) The module without laminator should be moved to the next process to prevent adhesion of dust.
- 2) How the remove dust on the polarizer
 - a) Blow out dust by the use of an N2 blower with antistatic measures taken. Use of an ionized air Gun is recommendable.
 - b) When the panel surface is soiled, wipe it with soft cloth.
- 3) In the case of the module's metal part (shield case) is stained, wipe it with a piece of dry, soft cloth. If rather difficult, give a breath on the metal part to clean better.
- 4) As a glass substrate is used for the TFT-LCD panel, if it is dropped on the floor or hit by something hard, it may be broken or chipped off. Take care of handling.
- 5) Since CMOS LSI is used in this module, take care of static electricity and take the human earth into consideration when handling.

10-5. Others

1) Regarding storage of LCD modules, avoid storing them at direct sunlight-situation.

You are requested to store under the following conditions:

(Environmental conditions of temperature/humidity for storage)

- a) Temperature: 0 to 40°C
- b) Relative humidity : 95% or less

As average values of environments (temperature and humidity) for storing, use the following control guidelines:

Summer season: 20 to 35°C, 85% or less Winter season: 5 to 15°C, 85% or less.

If stored under the conditions of 40°C and 95% RH, cumulative time of storage must be less than 240 hours.

- 2) If stored at temperatures below the rated values, the inner liquid crystal may freeze, causing cell destruction. At temperatures exceeding the rated values for storage, the liquid crystal may become isotropic liquid, making it no longer possible to come back to its original state in some cases. Please store as near room temperature as possible.
- 3) If the LCD is broken, do not drink liquid crystal in the mouth. If the liquid crystal adheres to a hand or foot or to clothes, immediately cleanse it with soap.
- 4) If a water drop or dust adheres for a long time, it is apt to cause deterioration. Wipe it immediately.
- 5) Be sure to observe other caution items for ordinary electronic parts and components.
- 6) When handling and assembling this LCD module, avoid using and storing this module for a long time at the place where Oxidization gas and Reduction gas (SO₂, H₂S etc) including the reagent, the adhesives and resin etc which generate these gases may exist in the atmosphere because of corrosion, discoloration, an abnormal display and operation of this module. An abnormal display by changing in quality of the polarizer might occur regardless of contact or no contact to the polarizing plate, because of epoxy resin (amine

system curing agent) that comes out from the material and the packaging material used for the set side, the silicon adhesive (dealcoholization system and oxime system), and the tray blowing agents (azo-compound), etc. Please confirm adaptability with your employed material.

11 Reliability test items

No.	Test item	Conditions			
1	High temperature storage test	Ta = 85°C, 240h			
2	Low temperature storage test	Ta = -30°C, 240h			
3	High temperature & high humidity operation test	Ta = 60°C , 90%RH, 240h (No condensation)			
4	High temperature operation test	Ta = 70°C, 240h			
5	Low temperature operation test	Ta = -10°C, 240h			
6	Vibration test (non-operating)	Frequency range: 10 to 55Hz, Stroke: 1.5mm Sweep time: 1min, Test period: 2hours for each direction of X, Y, Z			
7	Shock test	Direction: $\pm X$, $\pm Y$, $\pm Z$, Time: Third for each direction. Impact value: 980m/s ² , Action time 6ms			
8	Thermal shock test	Ta = -10°C to 70°C, 10 cycles (0.5h) (0.5h)			

[Note 11-1] Ta = Ambient temperature, Tp = Panel temperature

[Check items]

Test No.1 to No.8

In the standard condition, there shall be no practical problems that may affect the display function.

12. Display Grade

The standard regarding the grade of color LCD displaying modules should be based on the Incoming Inspection Standards (I.I.S.).

13. Delivery Form

- 13-1. Carton storage conditions
 - 1) Carton piling-up: Max 8 rows
 - 2) Environments

Temperature: 0~40°C

Humidity: 65% RH or less (at 40°C)

There should be no dew condensation even at a low temperature and high humidity.

Period : Approximately 3month

3) Packing form: As shown in Figure.

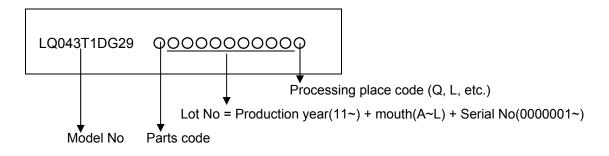
*Cartons are weak against damp, and they are apt to be smashed easily due to the compressive pressure applied when piled up. The above environmental conditions of temperature and humidity are set in consideration of reasonable pile-up for storage.

13-2. Packing composition

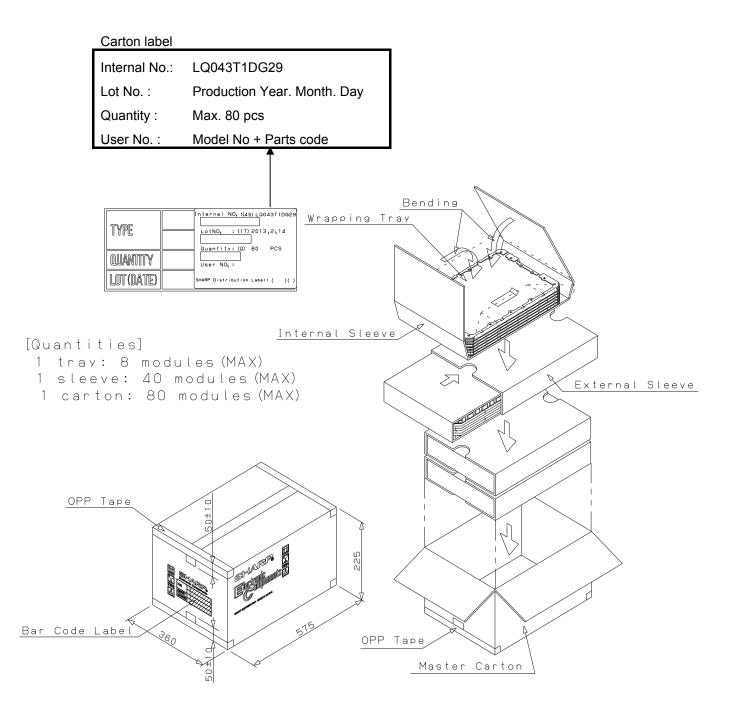
Name	quantity	Note	
Carton size	1	575×360×225 (mm)	
Тгау	12	Material: Electrification prevention polypropylene	
(The number of Module)	80	8 unit/tray: 80 unit/carton	
Electrification prevention bag	0	Material: Electrification prevention polyethylene	
	2	680mm(length)×500mm(depth)×50µm(thin)	

14. Lot No. marking

The lot No. will be indicated on individual inkjet. The location is as shown



15. LCD module packing carton



- 16. Others
 - 1) Disassembling the module can cause permanent damage and you should be strictly avoided.
 - 2) Please be careful that you don't keep the screen displayed fixed pattern image for a long time, since retention may occur.
 - 3) If you pressed down a liquid crystal display screen with your finger and so on, the alignment disorder of liquid crystal will occur. And then It will become display fault.

Therefore, be careful not to touch the screen directly, and to consider not stressing to it.

4) If any problem arises regarding the items mentioned in this technical literature or otherwise, it should be discussed and settled mutually in a good faith for remedy and/or improvement.

